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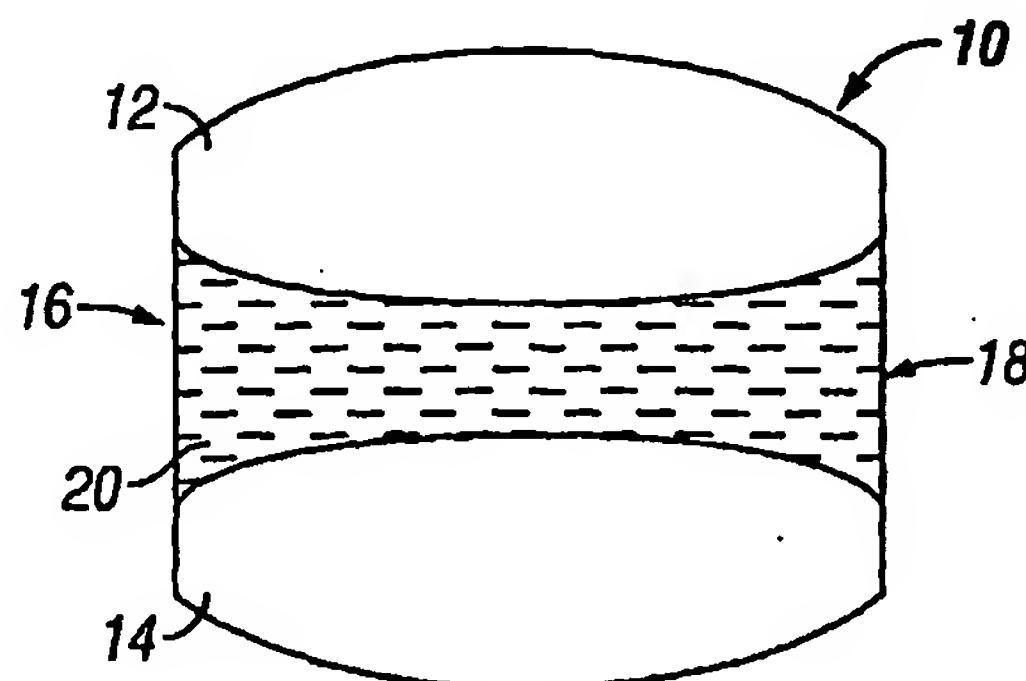
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(54) Title: USING ISOTOPICALLY SPECIFIED FLUIDS AS OPTICAL ELEMENTS



(57) Abstract: Embodiments of the present invention are directed to fluidic optical elements and systems using isotopically specified fluids for processing light passing therethrough. The isotopic composition of the fluid may be adjusted to vary the optical properties. The properties of the isotopically specified fluid may be monitored and adjusted to obtain the desired optical characteristics of the fluidic optical element. In one embodiment, a method of optically processing light comprises directing light through an optical element which includes an isotopically specified fluid disposed in a confined space. The isotopically specified fluid is selected to provide a preset desired effect on the light directed therethrough for optically processing the light.

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USING ISOTOPICALLY SPECIFIED FLUIDS AS OPTICAL ELEMENTS

CROSS-REFERENCES TO RELATED APPLICATIONS

- 5 [0001] This application is based on and claims the benefit of U.S. Provisional Patent Application No. 60/484,276, filed July 1, 2003, the entire disclosure of which is incorporated herein by reference.

BACKGROUND OF THE INVENTION

- 10 [0002] The present invention relates generally to optical systems and elements and, more particularly, to the use of isotopically specified fluids as optical elements including applications in immersion lithography.

- [0003] An exposure apparatus is one type of precision assembly that is commonly used to transfer images from a reticle onto a semiconductor wafer during semiconductor processing.
- 15 A typical exposure apparatus includes an illumination source, a reticle stage assembly that retains a reticle, an optical assembly (sometimes referred to as a projection lens), a wafer stage assembly that retains a semiconductor wafer, a measurement system, and a control system. The resist coated wafer is placed in the path of the radiation emanating from a patterned mask and exposed by the radiation. When the resist is developed, the mask pattern
- 20 is transferred onto the wafer. In microscopy, extreme ultra violet (EUV) radiation is transmitted through a thin specimen to a resist covered plate. When the resist is developed, a topographic shape relating to the specimen structure is left.

- [0004] Immersion lithography is a technique which can enhance the resolution of projection lithography by permitting exposures with numerical aperture (NA) greater than
- 25 one, which is the theoretical maximum for conventional "dry" systems. By filling the space between the final optical element and the resist-coated target (i.e., wafer) with an immersion fluid, immersion lithography permits exposure with light that would otherwise be totally internally reflected at an optic-air interface. Numerical apertures as high as the index of the immersion liquid (or of the resist or lens material, whichever is least) are possible. Liquid
- 30 immersion also increases the wafer depth of focus, i.e., the tolerable error in the vertical position of the wafer, by the index of the immersion liquid compared to a dry system with the

same numerical aperture. Immersion lithography thus has the potential to provide resolution enhancement equivalent to the shift from 248 to 193 nm. Unlike a shift in the exposure wavelength, however, the adoption of immersion would not require the development of new light sources, optical materials, or coatings, and should allow the use of the same or similar resists as conventional lithography at the same wavelength. In an immersion system where only the final optical element of the optical assembly and its housing and the wafer (and perhaps the stage as well) are in contact with the immersion fluid, much of the technology and design developed for conventional tools in areas such as contamination control, carry over directly to immersion lithography.

[0005] The immersion fluid in an immersion lithography system serves as a fluidic optical element. Fluids can also be used to form optical elements such as those inside the optical assembly of an exposure apparatus. The use of a fluid as an optical element raises certain issues and challenges but also provides new opportunities.

BRIEF SUMMARY OF THE INVENTION

[0006] Embodiments of the present invention are directed to fluidic optical elements and systems using isotopically specified fluids for processing light passing therethrough. The isotopic composition of the fluid may be adjusted to vary the optical properties. The properties of the isotopically specified fluid may be monitored and adjusted to obtain the desired optical characteristics of the fluidic optical element. Examples of such properties include the isotopic composition, index of refraction, temperature, and pressure. Water has optical properties that are suitable as the immersion fluid in an immersion lithography system. Water further has mechanical properties such as low viscosity and surface tension characteristics that render it particularly desirable for use in immersion lithography. The index of refraction of an immersion fluid plays a role in the imaging during lithography. Generally, an immersion fluid having a higher index of refraction is more desirable. The heavier isotopes of water can provide a desired higher index of refraction.

[0007] In accordance with an aspect of the present invention, a method of optically processing light comprises directing light through an optical element which includes an isotopically specified fluid disposed in a confined space. The isotopically specified fluid is selected to provide a preset desired effect on the light directed therethrough for optically processing the light.

[0008] In some embodiments, the isotopically specified fluid comprises one or more isotopes of a fluid. The isotopically specified fluid may comprise a plurality of isotopes of a fluid, and an isotopic composition of the fluid is monitored. The method further comprises adjusting amounts of the plurality of isotopes of the fluid to change the isotopic composition
5 based on the monitored isotopic composition of the fluid. The method may also comprise adjusting amounts of the plurality of isotopes of the fluid to form a variable isotopic composition of the fluid to provide variable optical characteristics of the optical element.

[0009] In specific embodiments, the isotopically specified fluid comprises one or more isotopes of water. The method further comprises positioning the optical element in an
10 immersion lithography apparatus at a location between an optical assembly and a substrate to be processed by lithography, wherein the light is directed through the optical assembly and the optical element to the substrate. The isotopically specified fluid of the optical element has a first index of refraction and the confined space is provided in a container comprising a material having a second index of refraction which is different from the first index of
15 refraction. The method further comprises recirculating the isotopically specified fluid between the confined space of the optical element and a recirculation reservoir. The method may also comprise controlling at least one of a temperature, a pressure, and an isotopic composition of the isotopically specified fluid in the optical element. The confined space is provided in a container which comprises fused silica. The light has a wavelength of about
20 193 nm or greater.

[0010] In accordance with another aspect of the invention, an optical element comprises a container and an isotopically specified fluid disposed in the container. The isotopically specified fluid is selected to provide a preset desired effect on a light directed therethrough for optically processing the light.

25 [0011] In accordance with another aspect of the present invention, an optical system for processing a substrate comprises an optical assembly spaced from a substrate by a space and an optical element disposed in the space between the optical assembly and the substrate. The optical element includes an isotopically specified fluid selected to provide a preset desired effect on a light directed therethrough for optically processing the light.

BRIEF DESCRIPTION OF THE DRAWINGS

[0012] Fig. 1 is a simplified schematic view of an optical assembly including an optical element having an isotopically specified fluid according to an embodiment of the present invention.

5 [0013] Fig. 2 is an elevational view of an optical element having an isotopically specified fluid according to another embodiment of the present invention.

[0014] Fig. 3 is a simplified schematic view of a fluidic system for an optical element illustrating a recirculation arrangement according to another embodiment of the present invention.

10 [0015] Fig. 4 is a simplified schematic view of a fluidic system for an optical element illustrating an open system arrangement according to another embodiment of the present invention.

[0016] Fig. 5 is a simplified schematic view of an immersion lithography system employing an isotopically specified fluid according to another embodiment of the present
15 invention.

[0017] Fig. 6 is a plot of refractive index versus D₂O concentration in water based on calculations.

DETAILED DESCRIPTION OF THE INVENTION

20 [0018] Fig. 1 shows an optical assembly 10 including two solid optical elements 12, 14, and a fluidic optical element 16 disposed therebetween. In the specific embodiment shown, the solid optical elements 12, 14 are converging lenses and the fluidic optical element 16 is a diverging lens. The solid optical elements 12, 14 may be made of glass or the like. The fluidic optical element 16 includes an isotopically specified fluid 20 disposed in a confined
25 space defined by the surfaces of the two solid optical elements 12, 14 and a side wall 18. The side wall 18 is sealed to the solid optical elements 12, 14. The side wall 18 may be made of a transparent material such as glass.

[0019] As used herein, the term "isotopically specified fluid" refers to a fluid of defined chemical composition, where the molecules making up the fluid are distinguished by the
30 specific isotopes of their elemental constituents, the corresponding molecular weight, and their concentration in the fluid. For example, for the case of water, the basic molecular

constituent is H₂O and the fluid would be characterized by information similar to the following:

Table 1

Molecular constituents	Molecular weight	Concentration	Comments
H ₂ O ¹⁶	18	0.99985	H = most abundant isotope of hydrogen; O ¹⁶ = most abundant isotope of oxygen
HDO ¹⁶	19	<10 ⁻⁵	D = deuterium, heavy isotope of hydrogen
D ₂ O ¹⁶	20	0.00015	
H ₂ O ¹⁷	19	<10 ⁻⁵	
HDO ¹⁷	20	<10 ⁻⁵	
D ₂ O ¹⁷	21	<10 ⁻⁵	
H ₂ O ¹⁸	20	<10 ⁻⁵	
HDO ¹⁸	21	<10 ⁻⁵	
D ₂ O ¹⁸	22	<10 ⁻⁵	

- 5 [0020] Only stable isotopes are listed in Table 1. Radioactive isotopes, for the case of water, are short lived enough that they are not likely to be present in a high enough concentration to be significant. In other fluids however, radioactive isotopes may have to be considered as well. Table 1 is representative of "normal water" which contains approximately 0.015% heavy water. The concentrations labeled "<10⁻⁵" represent levels
- 10 below which no significant change in refractive index occurs. In the case of water, a change of approximately 10⁻⁵ may change the refractive index by about 1 ppm which is assumed to be insignificant for the present application. For other fluids and applications the level of significant concentration would have to be determined.

- [0021] Fig. 2 shows another fluidic optical element 30 including an isotopically specified
- 15 fluid 32 disposed in a container 34. The container 34 may be made of glass, fused silica, or the like. In some cases, the isotopically specified fluid 32 has a first index of refraction and the material of the container 34 has a second index of refraction which is different from the first index of refraction. The isotopically specified fluid 32 may include a plurality of isotopes of a fluid. Different isotopes have different optical properties such as the index of
- 20 refraction. The amounts of the plurality of isotopes of the fluid may be adjustable to form a variable isotopic composition of the fluid to provide variable optical characteristics of the optical element. In addition to the isotopically specified fluid, the shape of the container 34,

the optical properties of the container material, and the configuration of the cavity for the isotopically specified fluid 32 in the container 34 can be selected to produce the desired characteristics of the fluidic optical element 30.

[0022] The fluidic optical element 30 has two materials, namely, the material of the isotopically specified fluid 32 and the material of the container 34. This makes it possible to correct for chromatic aberrations or spectral dispersions. Some prior optical elements rely on the introduction of calcium fluoride into fused silica or a similar glass material to form a solid optical element. While calcium fluoride provides suitable optical properties, it is difficult and expensive to produce due to its crystalline nature and it introduces certain undesirable material properties such as intrinsic birefringence, as well as additional birefringence arising from mechanical stress in the optical element. The isotopically specified fluid 32 in the fluidic optical element 30 may replace the use of calcium fluoride in some prior optical elements.

[0023] Fig. 3 shows a system 40 for providing a fluidic optical element 42 to process light passing therethrough. In this closed system, the isotopically specified fluid is recirculated between the optical element 42 and a reservoir 44. One or more sensors 48 are used to monitor the properties of the isotopically specified fluid, such as the isotopic composition, index of refraction, temperature, pressure, and the like. In Fig. 3, the sensors 48 are coupled to the reservoir 44, but may be coupled to the optical element 42 or another part of the recirculation system to monitor the fluid. The sensor information is provided from the sensors 48 to a controller 50, which adjusts the properties of the isotopically specified fluid based on the sensor information, such as controlling any of the temperature, pressure, index of refractions, and isotopic composition of the fluid.

[0024] Fig. 4 shows an open system 60 for providing a fluidic optical element 62 to process light passing therethrough. The isotopically specified fluid is supplied to the optical element 62 from a source 64 and exits the optical element 62 to a drain 66. One or more sensors 68 are coupled to the optical element 62 or another part of the flow path upstream or downstream of the optical element 62, and are used to monitor the properties of the isotopically specified fluid. The sensor information is provided from the sensors 68 to a controller 70 which adjusts the properties of the isotopically specified fluid based on the sensor information.

[0025] The closed and open flow systems of Figs. 3 and 4 maintain a constant flow of the isotopically specified fluid through the fluidic optical elements. The flow can ensure uniformity of the isotopically specified fluid and properties of the optical elements, and can eliminate the formation of voids or the like. It can also facilitate monitoring and control of the isotopically specified fluid for the optical elements.

[0026] Fig. 5 shows an immersion lithography system 110 including a reticle stage 112, a projection lens or optical assembly 114, and a wafer or substrate 116 supported on a wafer stage 118. An immersion apparatus 120 is disposed between the final optical element 122 of the lens 114 and the wafer 116 to provide an immersion fluid therebetween. In the present embodiment, the immersion fluid is an isotopically specified fluid, and forms a fluidic optical element in the path of the light between the lens 114 and the wafer 116. The isotopically specified fluid is typically provided as a continuous flow through the space between the lens 114 and the wafer 116 to form the fluidic optical element.

[0027] The system for providing the isotopically specified fluid to the immersion lithography system 110 is preferably a closed immersion fluid control system, where the fluid is recovered and recycled after exposure of a wafer. This is highly desirable since it is important to maintain the isotopic composition and thus the fluid's optical properties, and because at least some of the isotopes are likely to be rare and expensive. Even the vapor from the fluid should be recovered. A system with many of the desired characteristics is described in PCT Application No. PCT/US04/10055, entitled Environmental System Including Vacuum Scavenge For An Immersion Lithography Apparatus, filed March 29, 2004. Additional components may be used to ensure the purity and/or optical properties of the fluid. Some change in isotopic composition may occur from small differences in chemical reactivities or physical properties among the isotopes. Also some impurities may be introduced into the fluid. The chemical and isotopic composition can be monitored, for example, using either optical or mass spectroscopy. Alternatively, the optical properties such as the refractive index can be monitored using a refractometer, and appropriate isotopic molecular constituents added to maintain the property at a constant value. Since impurities may affect the refractive index, this method may maintain a constant index even though the basic chemical composition of the fluid is changing.

[0028] The isotopically specified fluid is selected to provide a preset desired effect on a light directed therethrough for optically processing the light, for example, to perform a

lithography procedure. The isotopically specified fluid may include a plurality of isotopes of a fluid. The fluid should not react with surrounding components such as the container of the fluidic optical element, the neighboring optical components, and substrates with which the fluid has contact. Water is particularly suitable for certain applications in lithography. Water is generally stable and nonreactive with other optical components and substrates. If water forms part of the optics in a system such as a lithography system, the optical properties of water will need to be known to almost ppm accuracy. The optical properties of water are being measured.

[0029] Water may play an important role in immersion lithography. Water has very low optical absorption at wavelengths as short as 193 nm which is the wavelength of an ArF beam. Water has a relatively low viscosity. Thus wafer stage motion and vibrations may not couple through the water to the projection lens to an unacceptable extent. It is important to monitor the isotopic purity or composition of water, since the different isotopes can have significantly different optical properties. First, different sources of water may have slightly different isotopic compositions, leading to possibly significant differences in optical properties. Second, the index of refraction of water can be varied significantly by varying the isotopic composition, which may allow some amount of tuning of the projection optics design. Third, water tuned to an appropriate index of refraction may be introduced elsewhere in the projection optics, to tune the optics further. Because the optical dispersion of water differs from that of fused silica, some amount of chromatic correction is possible.

[0030] The refractive indices of the water isotopes are not well determined at the short wavelengths used in optical lithography. The refractive indices for the various isotopes of water are estimated here from the Lorentz-Lorenz model of molecular polarizability:

$$(n^2 - 1) / (n^2 + 2) = A\rho ,$$

where n is the index of refraction, ρ is the density, and A is an empirical constant. If one assumes that A is the empirical constant for ordinary water, the isotope effect arises basically from changes in the density. Ordinary water is presumed to be H_2^{16}O . Normal "heavy" water D_2O is taken to be D_2^{16}O , where D is deuterium (^2H), the heavy isotope of hydrogen. Of course, there are other isotopes including HDO and heavier isotopes of oxygen, ^{17}O and ^{18}O , which will add to the density effect. At a temperature of 30°C for a wavelength of 193 nm, the constant A for ordinary water is about 0.262936. Table 2 shows the calculated results of the index of refractive for different isotopes of water. The index of refraction of an

immersion fluid plays a role in the imaging during lithography. Generally, an immersion fluid having a higher index of refraction is more desirable. The heavier isotopes of water may provide the desired higher index of refraction.

[0031] The above model cannot represent a complete description of the optical properties of the water isotopes, because it neglects differences in the molecular energy levels among the isotopes. Therefore Table 2 represents an approximation. Better measurements of the refractive index of the water isotopes are desirable to confirm or adjust these numbers. The differences in the indices of refraction among the isotopes also cause some difference in the optical absorption of the different isotopes.

10 Table 2

Isotope	Density ρ (gram/cc)	Index of Refraction
H ₂ O	0.995678	1.43664
D ₂ O	1.10315	1.49188
D ₂ ¹⁷ O	1.158308	1.52112
D ₂ ¹⁸ O	1.213465	1.55103

[0032] The natural abundance of heavy water is about 0.015%. This causes a change of about 8 ppm in the refractive index from that of pure H₂O, possibly a significant difference. Fig. 6 shows a plot of the variation in refractive index with different concentrations of heavy water based on calculations. Pure D₂O has a refractive index of about 1.492, which is close to the refractive index of calcium fluoride (Ca₂F) of about 1.50 at the wavelength of 193 nm. Therefore, heavy water may be able to replace some Ca₂F for chromatic corrections in an optical system containing optical elements formed of fused silica or the like. Table 3 further lists the index of refraction and dispersion at 193 nm for fused silica, calcium fluoride, and different isotopes of water based on calculations. The dispersion of the water isotopes has not been measured at 193 nm. At longer wavelengths, the dispersion of D₂O is lower than that of H₂O.

Table 3

Material	Index of Refraction (n)	Dispersion (dn/dλ)
Fused Silica	1.5607	-0.00158
Ca ₂ F	1.502	-0.00099
H ₂ O	1.4355	-0.00199
D ₂ O	1.49188	not measured at 193 nm
D ₂ ¹⁷ O	1.52112	not measured at 193 nm
D ₂ ¹⁸ O	1.55103	not measured at 193 nm

[0033] It is to be understood that the above description is intended to be illustrative and not restrictive. Many embodiments will be apparent to those of skill in the art upon reviewing the above description. The scope of the invention should, therefore, be determined not with
5 reference to the above description, but instead should be determined with reference to the appended claims along with their full scope of equivalents.

WHAT IS CLAIMED IS:

- 1 1. A method of optically processing light, the method comprising:
2 directing light through an optical element which includes an isotopically
3 specified fluid disposed in a confined space,
4 wherein the isotopically specified fluid is selected to provide a preset desired
5 effect on the light directed therethrough for optically processing the light.
- 1 2. The method of claim 1 wherein the isotopically specified fluid
2 comprises one or more isotopes of a fluid.
- 1 3. The method of claim 2 wherein the isotopically specified fluid
2 comprises a plurality of isotopes of a fluid, and further comprising monitoring an isotopic
3 composition of the fluid.
- 1 4. The method of claim 3 further comprising adjusting amounts of the
2 plurality of isotopes of the fluid to change the isotopic composition based on the monitored
3 isotopic composition of the fluid.
- 1 5. The method of claim 2 further comprising adjusting amounts of the
2 plurality of isotopes of the fluid to form a variable isotopic composition of the fluid to
3 provide variable optical characteristics of the optical element.
- 1 6. The method of claim 1 wherein the isotopically specified fluid
2 comprises one or more isotopes of water.
- 1 7. The method of claim 1 further comprising positioning the optical
2 element in an immersion lithography apparatus at a location between an optical assembly and
3 a substrate to be processed by lithography, wherein the light is directed through the optical
4 assembly and the optical element to the substrate.
- 1 8. The method of claim 1 wherein the isotopically specified fluid of the
2 optical element has a first index of refraction and the confined space is provided in a
3 container comprising a material having a second index of refraction which is different from
4 the first index of refraction.

1 9. The method of claim 1 further comprising recirculating the isotopically
2 specified fluid between the confined space of the optical element and a recirculation
3 reservoir.

1 10. The method of claim 1 further comprising controlling at least one of a
2 temperature, a pressure, and an isotopic composition of the isotopically specified fluid in the
3 optical element.

1 11. The method of claim 1 wherein the confined space is provided in a
2 container which comprises fused silica.

1 12. The method of claim 1 wherein the light has a wavelength of about
2 193 nm or greater.

1 13. An optical element comprising:
2 a container; and
3 an isotopically specified fluid disposed in the container,
4 wherein the isotopically specified fluid is selected to provide a preset desired
5 effect on a light directed therethrough for optically processing the light.

1 14. The optical element of claim 13 wherein the isotopically specified fluid
2 comprises one or more isotopes of a fluid.

1 15. The optical element of claim 14 wherein the isotopically specified fluid
2 comprises a plurality of isotopes of a fluid, and wherein amounts of the plurality of isotopes
3 of the fluid are adjustable to form a variable isotopic composition of the fluid to provide
4 variable optical characteristics of the optical element.

1 16. The optical element of claim 13 wherein the isotopically specified fluid
2 comprises one or more isotopes of water.

1 17. The optical element of claim 13 wherein the isotopically specified fluid
2 of the optical element has a first index of refraction and the container comprises a material
3 having a second index of refraction which is different from the first index of refraction.

1 18. The optical element of claim 13 wherein the confined space is
2 provided in a container which comprises fused silica.

- 1 19. An optical system for processing a substrate, the optical system
2 comprising:
3 an optical assembly spaced from a substrate by a space; and
4 an optical element disposed in the space between the optical assembly and the
5 substrate, the optical element including an isotopically specified fluid to provide a preset
6 desired effect on a light directed therethrough for optically processing the light.
- 1 20. The optical system of claim 19 wherein the isotopically specified fluid
2 comprises one or more isotopes of a fluid.
- 1 21. The optical system of claim 20 wherein the isotopically specified fluid
2 comprises a plurality of isotopes of a fluid, and wherein amounts of the plurality of isotopes
3 of the fluid are adjustable to form a variable isotopic composition of the fluid to provide
4 variable optical characteristics of the optical element.
- 1 22. The optical system of claim 19 wherein the isotopically specified fluid
2 comprises one or more isotopes of water.
- 1 23. The optical system of claim 19 wherein a continuous flow of the
2 isotopically specified fluid is provided through the space between the optical assembly and
3 the substrate to form the optical element.
- 1 24. The optical system of claim 19 wherein the refractive index of the
2 isotopically specified fluid is greater than about 1.45.
- 1 25. A lithography system in which the substrate is exposed by radiation
2 through the optical system as recited in claim 19.

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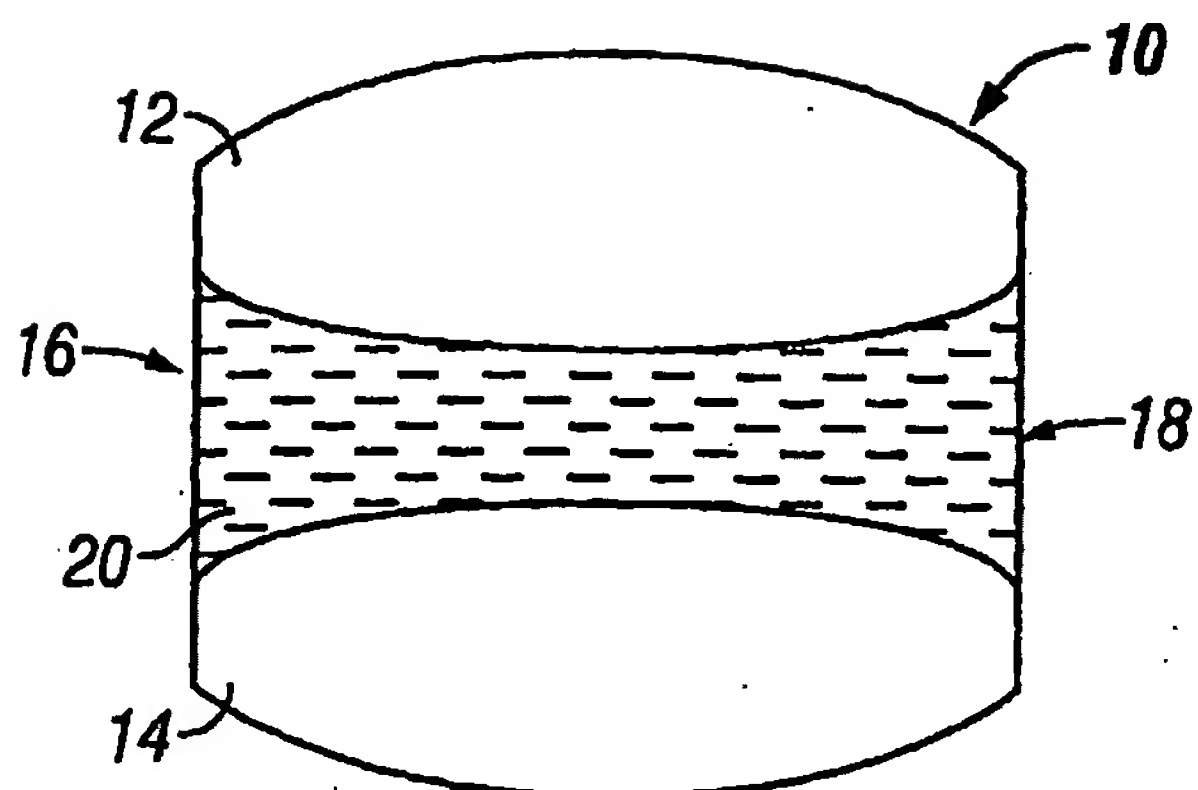


FIG. 1

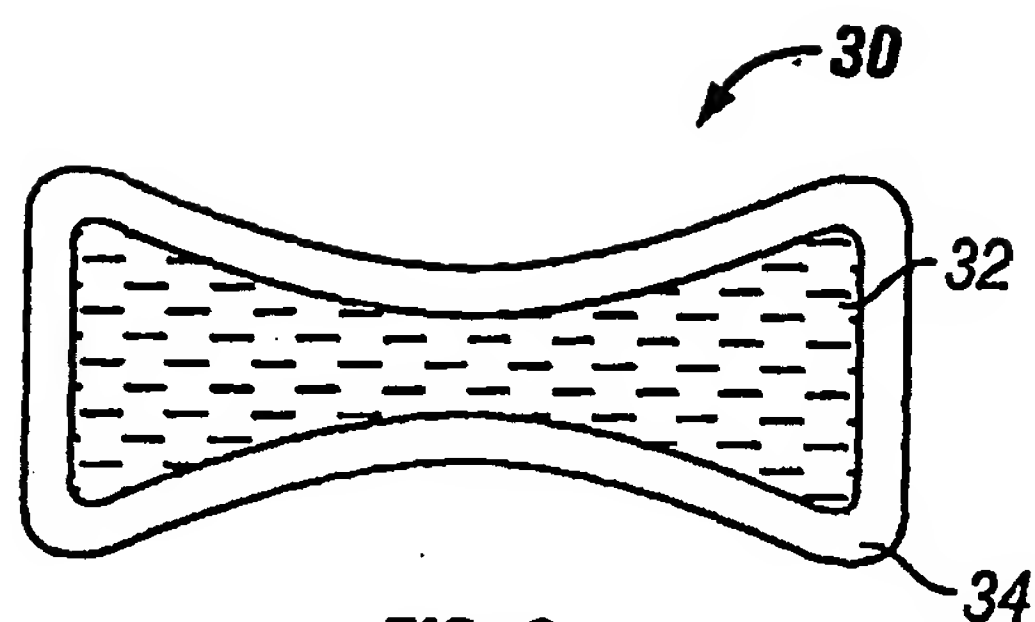


FIG. 2

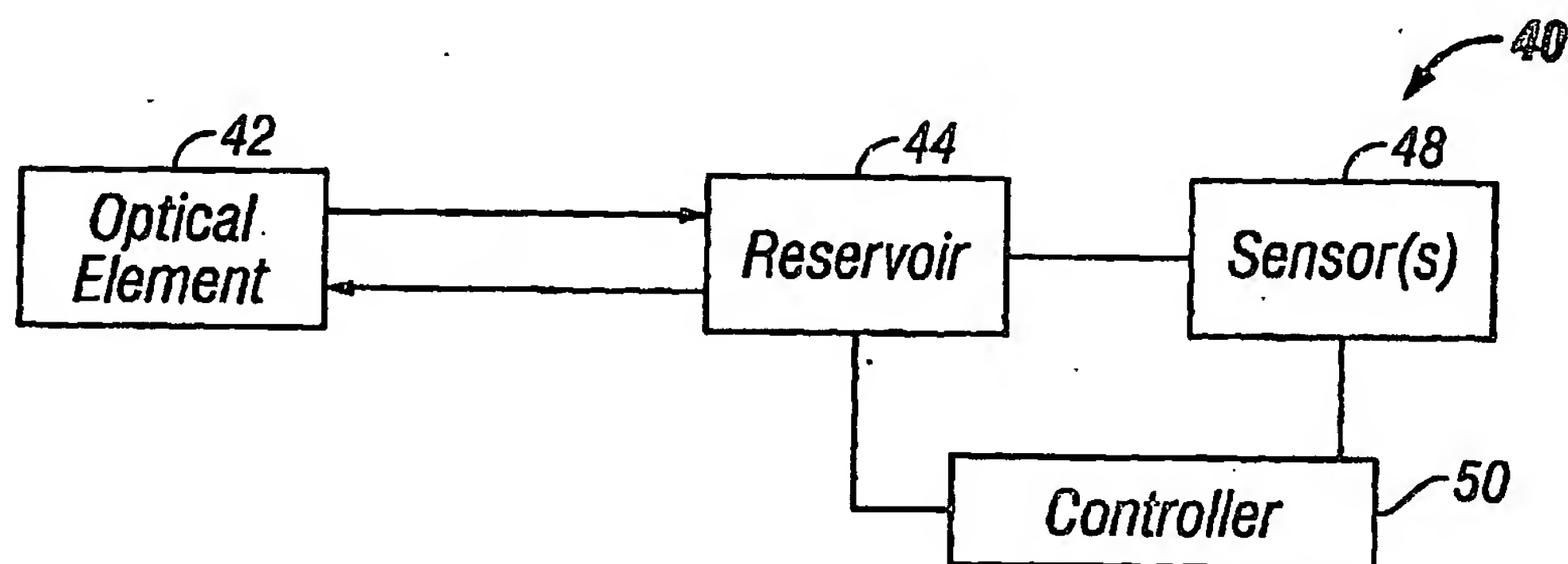


FIG. 3

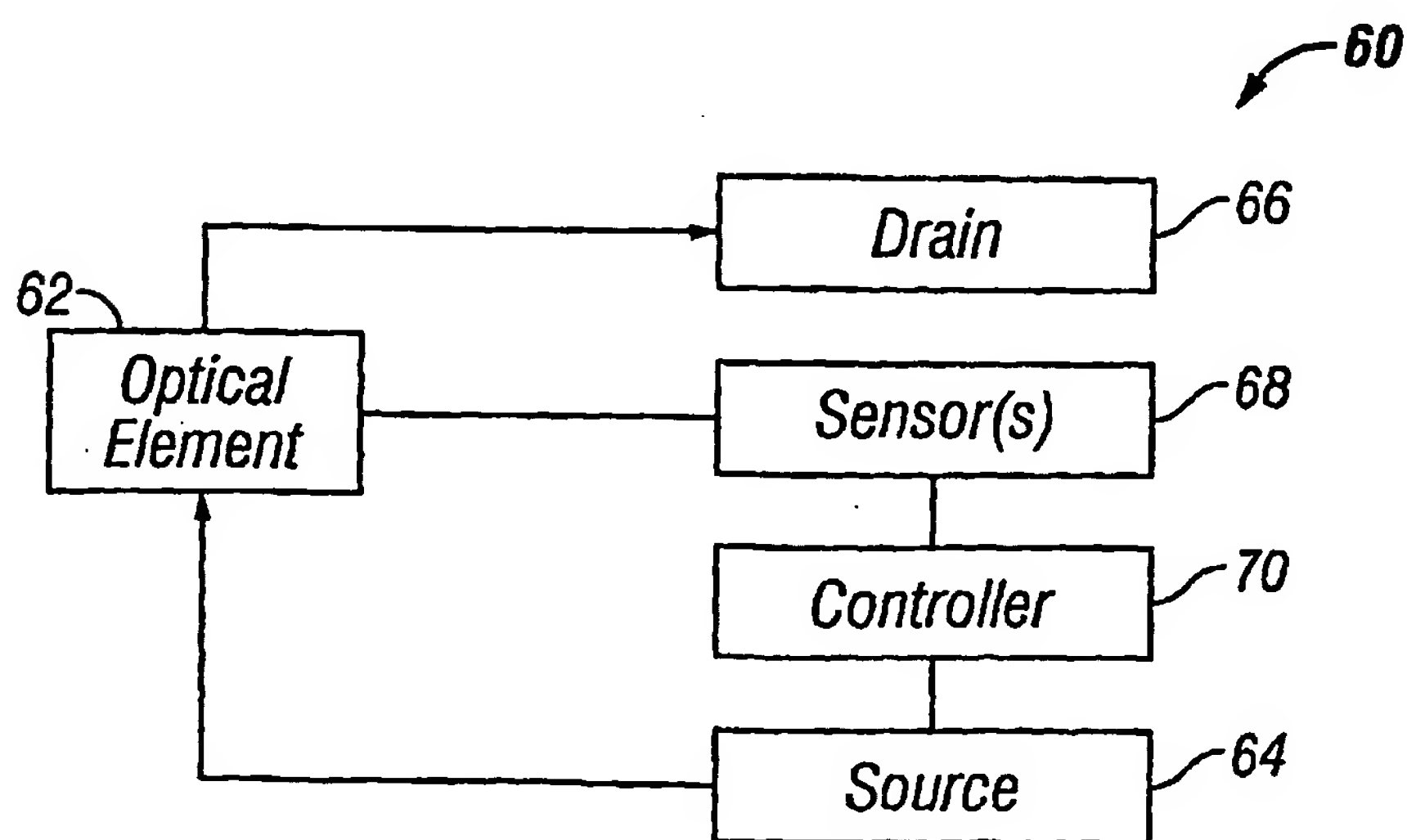


FIG. 4

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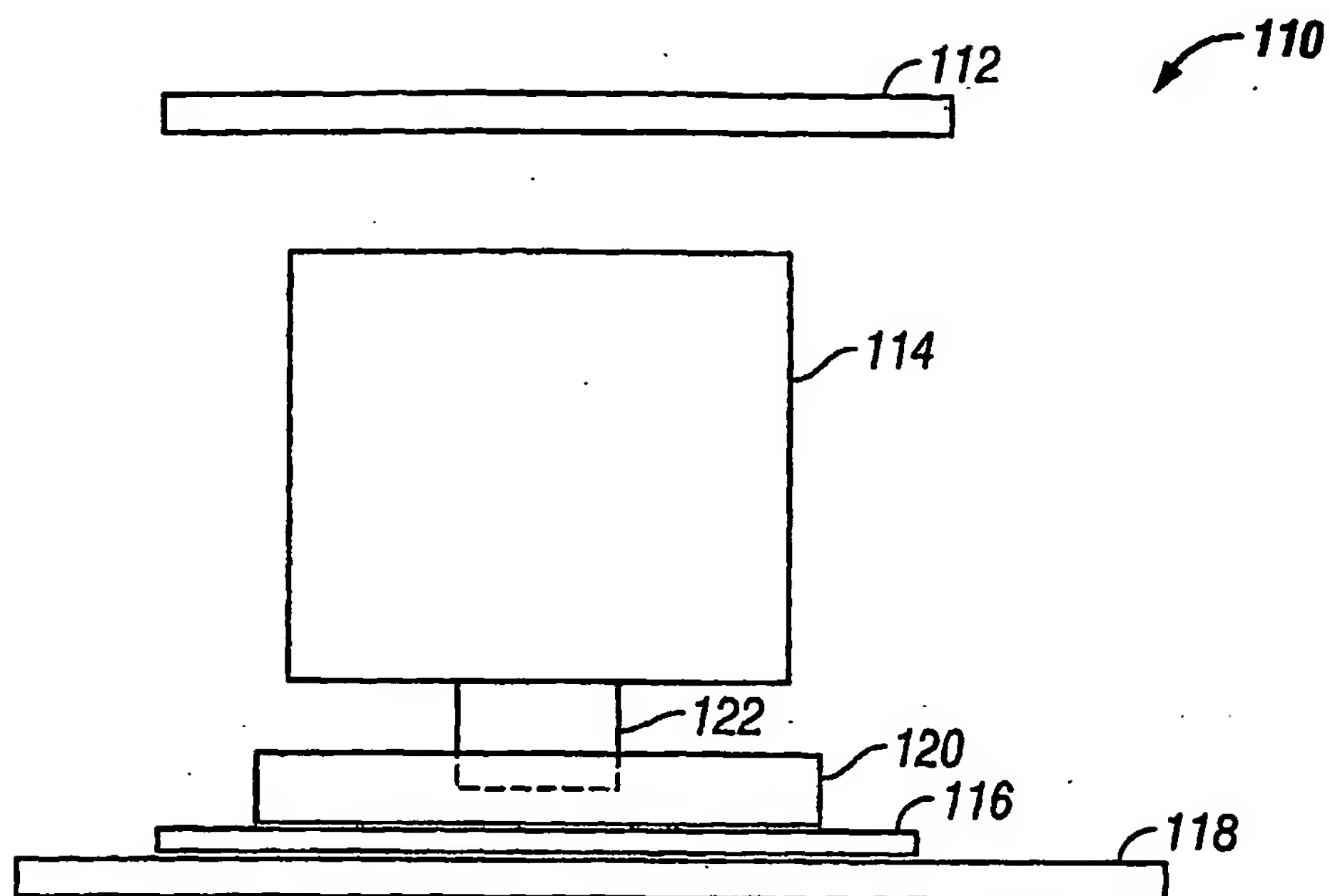


FIG. 5

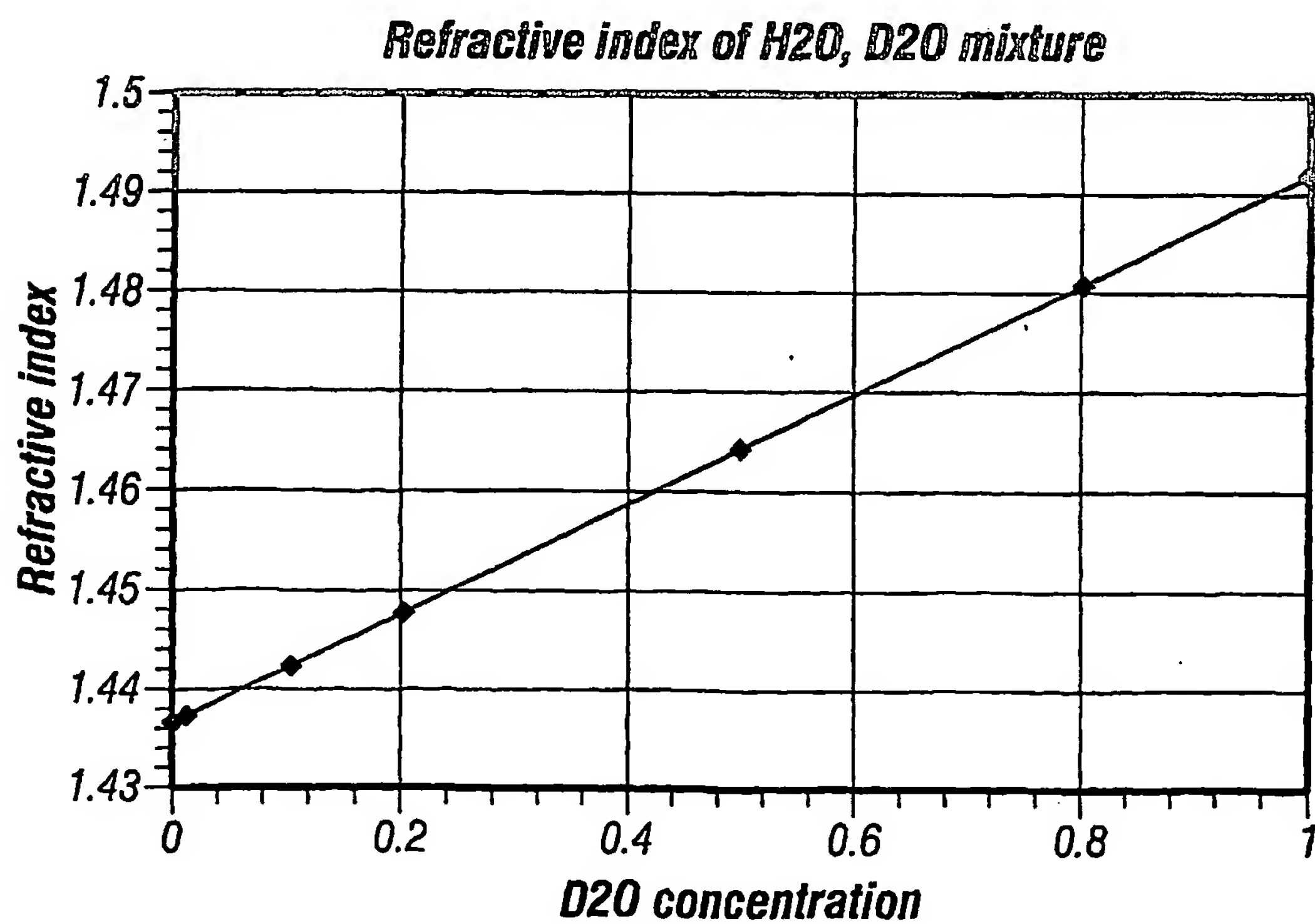


FIG. 6

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ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM),
European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI,
FR, GB, GR, HU, IE, IT, LU, MC, NL, PL, PT, RO, SE, SI,
SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ,
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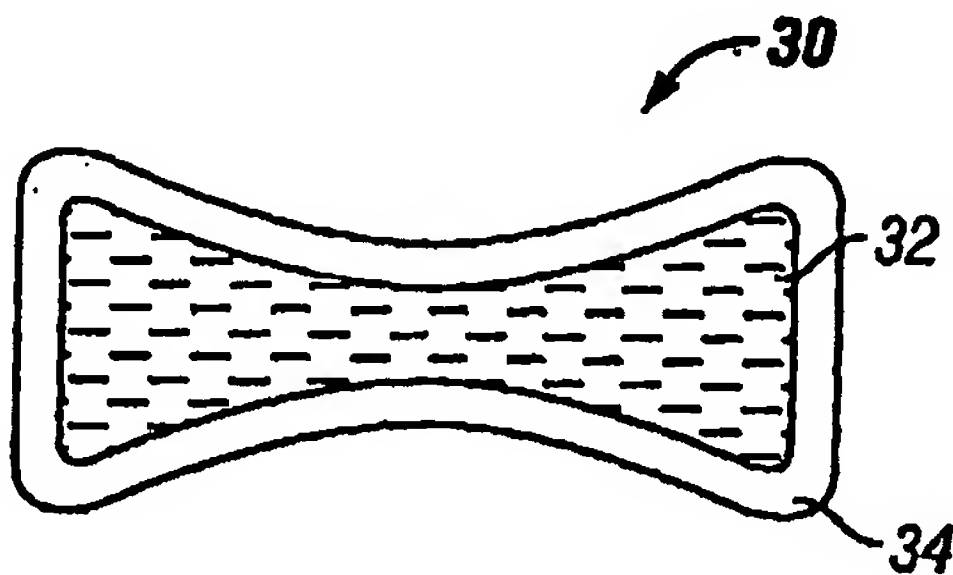
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For two-letter codes and other abbreviations, refer to the "Guid-
ance Notes on Codes and Abbreviations" appearing at the begin-
ning of each regular issue of the PCT Gazette.

(54) Title: USING ISOTOPICALLY SPECIFIED FLUIDS AS OPTICAL ELEMENTS



(57) Abstract: Embodiments of the present invention are directed to fluidic optical elements (30) and lithographic systems using isotopically specified fluids (32) for processing light passing therethrough. The isotopic composition of the fluid may be adjusted to vary the optical properties. The properties of the isotopically specified fluid may be monitored and adjusted to obtain the desired optical characteristics of the fluidic optical element. In one embodiment, a method of optically processing light comprises directing light through an optical element (34) which includes an isotopically specified fluid disposed in a confined space. The isotopically specified fluid is selected to provide a preset desired effect on the light directed therethrough for optically processing the light.

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INTERNATIONAL SEARCH REPORT

International application No.

PCT/US04/21159

A. CLASSIFICATION OF SUBJECT MATTER

IPC(7) : G02B 3/12

US CL : 359/832

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

U.S. : 359/832, 665-667, 509, 507, 355

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)
EAST (keywords: lithography, isotope, immersion)

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 6,097,532 A (HARRIS et al) 1 August 2000 (01.08.2000), figure 4	1-5, 8-10, 13-15, 17
X	US 5,610,683 A (TAKAHASHI) 11 March 1997 (11.03.1997), figure 1-3	1, 2, 7-10, 13, 14, 17, 19, 20, 22-25
Y		-----
Y	US 6,381,013 B1 (RICHARDSON) 30 April 2002 (30.04.2002), detailed description	6, 11, 12, 16, 18, 22 6, 11, 12, 16, 18, 22

☐ Further documents are listed in the continuation of Box C.

☐ See patent family annex.

* Special categories of cited documents:

"A" document defining the general state of the art which is not considered to be of particular relevance

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"O" document referring to an oral disclosure, use, exhibition or other means

"P" document published prior to the international filing date but later than the priority date claimed

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document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone

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"&"

document member of the same patent family

Date of the actual completion of the international search

18 March 2005 (18.03.2005)

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10 JUN 2005

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~~0800-1300~~

Det

arranged for generating a purge gas mixture which purge gas mixture comprises at least one purging gas and said moisture; and
a purge gas outlet (130-132) for supplying the purge gas mixture to said at least part of the lithographic projection apparatus.